

3.4mm RIGHT ANGLE LED INDICATOR

Part Number: L-1387QMP/1GYW

Green Yellow

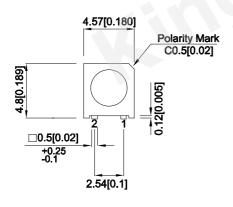
Features

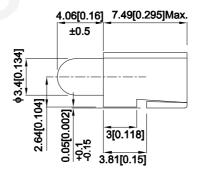
- Surface mount type.
- Black case enhances contrast ratio.
- Wide viewing angle.
- High reliability life measured in years.
- Package:1000pcs / reel.
- Moisture sensitivity level : level 3.
- Housing UL rating:94V-0.
- Housing material: PPA.
- High temperature resistant housing.
- High glass transition temperature epoxy.
- RoHS compliant.

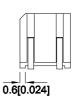
Descriptions

- The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.
- The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

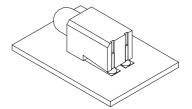
Package Dimensions











Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 SPEC NO: DSAD0323
 REV NO: V.13B
 DATE: JUN/17/2016
 PAGE: 1 OF 7

 APPROVED: Wynec
 CHECKED: Allen Liu
 DRAWN: L.T.Zhang
 ERP: 1102000482

Selection Guide

| Part No. | Emitting Color (Material) | Lens Type | lv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|----------------|---------------------------|-----------------|------------------------|------|----------------------|
| | | <i>,</i> . | Min. | Тур. | 201/2 |
| L-1387QMP/1GYW | Green (GaP) | White Diffused | 10 | 20 | 70° |
| | Yellow (GaAsP/GaP) | Willie Dilluseu | 5 | 10 | |

Notes:

- 1. 01 / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
 2. Luminous intensity / luminous Flux: + / -15%.
 3. Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Emitting Color | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|-----------------|------------|------------|-------|-----------------|
| λpeak | Peak Wavelength | Green Yellow | 565 590 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Green Yellow | 568 588 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Green Yellow | 30 35 | | nm | IF=20mA |
| С | Capacitance | Green Yellow | 15 20 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Green Yellow | 2.2 2.1 | 2.5 2.5 | V | IF=20mA |

Notes:

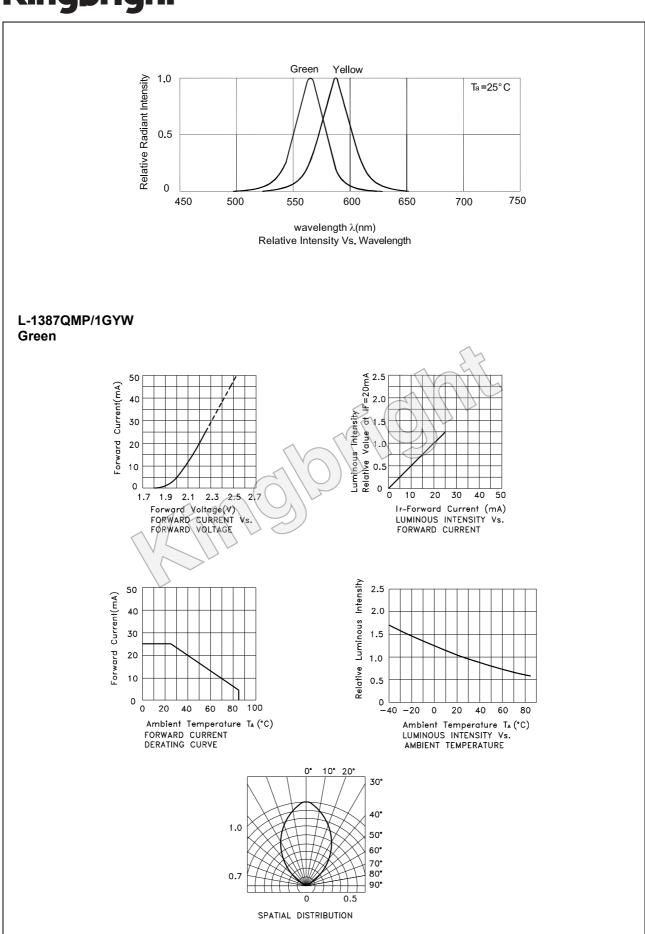
- Wavelength: + / -1nm.
 Forward Voltage: + / -0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

| <u> </u> | | | | | | | |
|---------------------------------|----------------|-----|-------|--|--|--|--|
| Parameter | Green Yellow | | Units | | | | |
| Power dissipation | 62.5 | 75 | mW | | | | |
| DC Forward Current | 25 | 30 | mA | | | | |
| Peak Forward Current [1] | 140 | 140 | mA | | | | |
| Operating / Storage Temperature | -40°C To +85°C | | | | | | |

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity - Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

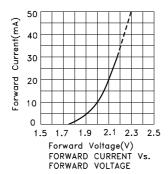
SPEC NO: DSAD0323 DATE: JUN/17/2016 **REV NO: V.13B** PAGE: 2 OF 7 **APPROVED: Wynec CHECKED: Allen Liu** DRAWN: L.T.Zhang ERP: 1102000482

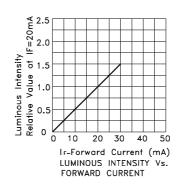


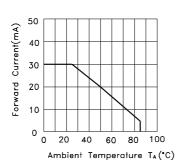
 SPEC NO: DSAD0323
 REV NO: V.13B
 DATE: JUN/17/2016
 PAGE: 3 OF 7

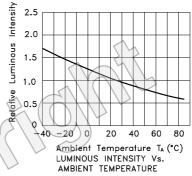
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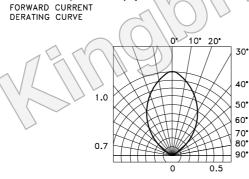
Yellow











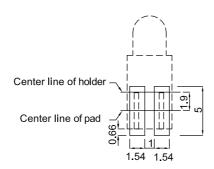
SPATIAL DISTRIBUTION

 SPEC NO: DSAD0323
 REV NO: V.13B
 DATE: JUN/17/2016
 PAGE: 4 OF 7

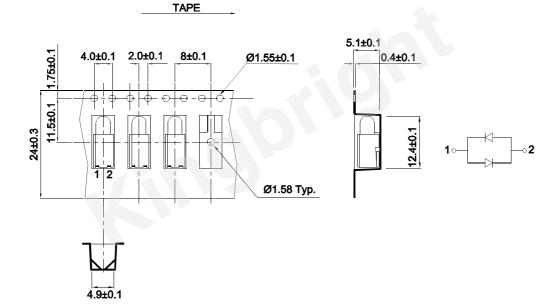
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Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)

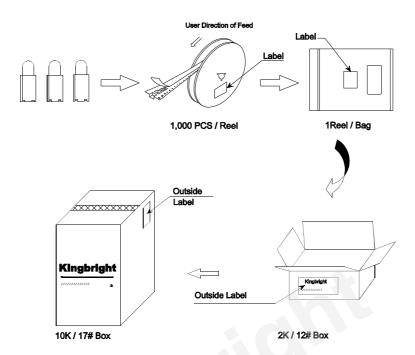


 SPEC NO: DSAD0323
 REV NO: V.13B
 DATE: JUN/17/2016
 PAGE: 5 OF 7

 APPROVED: Wynec
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PACKING & LABEL SPECIFICATIONS

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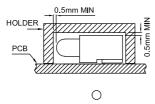
- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
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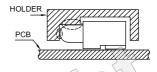
SPEC NO: DSAD0323 REV NO: V.13B DATE: JUN/17/2016 PAGE: 6 OF 7

APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang ERP: 1102000482

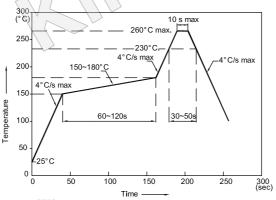
PRECAUTIONS

- 1.A moisture barrier bag (MBB) containing LEDs shall be kept in an environment with temperature below 40°C and humidity below 90% RH.
- A MBB shall be kept sealed until the LEDs contained in that bag are to be used immediately. Storge in an environment with temperature 5~30°C and humidity below 60% RH.
- 2.After a MBB has been opened, all LEDs contained in that bag shall complete soldering process within according to the conditions listed on the Kingbright MBB.
- 3.If the 10% spot of a humidity indicator card (HIC) indicates wet, LEDs shall be baked according to the conditions listed on the Kingbright MBB.
- 4.During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.





- 5. The tip of the soldering iron should never touch the lens epoxy.
- 6.After soldering, allow at least three minutes for the component to cool down to room temperature before further operations.
- 7.If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 8. Recommended Reflow Soldering Profiles For SMD Housing LEDs



- 1. We recommend the reflow temperature 245° C(±5° C). The maximum soldering temperature should be limited to 260°C.
- Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3.Recommended Solder Sn/Cu/Ag. 4.No more than once.

SPEC NO: DSAD0323 **REV NO: V.13B DATE: JUN/17/2016** PAGE: 7 OF 7 **APPROVED: Wynec CHECKED: Allen Liu** DRAWN: L.T.Zhang ERP: 1102000482